

Dual N-channel MOSFET

ELM14828AA-N

General description

ELM14828AA-N uses advanced trench technology to provide excellent $R_{ds(on)}$ and low gate charge.

Features

- $V_{ds}=60V$
- $I_d=4.5A$ ($V_{gs}=10V$)
- $R_{ds(on)} < 56m\Omega$ ($V_{gs}=10V$)
- $R_{ds(on)} < 77m\Omega$ ($V_{gs}=4.5V$)

Maximum absolute ratings

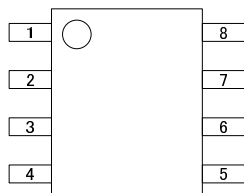
Parameter	Symbol	Limit	Unit	Note	
Drain-source voltage	V_{ds}	60	V		
Gate-source voltage	V_{gs}	± 20	V		
Continuous drain current	I_d	$T_a=25^\circ C$	4.5	A	1
		$T_a=70^\circ C$	3.6		
Pulsed drain current	I_{dm}	20	A	2	
Power dissipation	P_d	$T_a=25^\circ C$	2.00	W	
		$T_a=70^\circ C$	1.28		
Junction and storage temperature range	T_j, T_{stg}	-55 to 150	$^\circ C$		

Thermal characteristics

Parameter		Symbol	Typ.	Max.	Unit	Note
Maximum junction-to-ambient	$t \leq 10s$	$R\theta_{ja}$	48.0	62.5	$^\circ C/W$	1
Maximum junction-to-ambient	Steady-state		74.0	110.0	$^\circ C/W$	
Maximum junction-to-lead	Steady-state	$R\theta_{jl}$	35.0	60.0	$^\circ C/W$	3

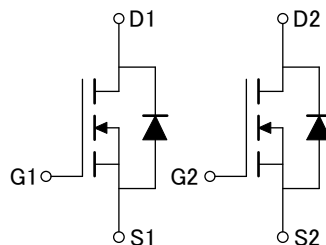
Pin configuration

SOP-8 (TOP VIEW)



Pin No.	Pin name
1	SOURCE2
2	GATE2
3	SOURCE1
4	GATE1
5	DRAIN1
6	DRAIN1
7	DRAIN2
8	DRAIN2

Circuit



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Electrical characteristics

Ta=25°C

Parameter	Symbol	Condition	Min.	Typ.	Max.	Unit	Note
STATIC PARAMETERS							
Drain-source breakdown voltage	BVdss	Id=250 μA, Vgs=0V	60			V	
Zero gate voltage drain current	Idss	Vds=60V Vgs=0V			1	μA	
		Tj=55°C			5		
Gate-body leakage current	Igss	Vds=0V, Vgs=±20V			100	nA	
Gate threshold voltage	Vgs(th)	Vds=Vgs, Id=250 μA	1.0	2.1	3.0	V	
On state drain current	Id(on)	Vgs=10V, Vds=5V	20			A	
Static drain-source on-resistance	Rds(on)	Vgs=10V Id=4.5A		46	56	mΩ	
		Tj=125°C		80	100		
		Vgs=4.5V, Id=3A		64	77	mΩ	
Forward transconductance	Gfs	Vds=5V, Id=4.5A		11		S	
Diode forward voltage	Vsd	Is=1A, Vgs=0V		0.74	1.00	V	
Max. body-diode continuous current	Is				3	A	
Pulsed body diode current	Ism				20	A	2
DYNAMIC PARAMETERS							
Input capacitance	Ciss	Vgs=0V, Vds=30V, f=1MHz		450	540	pF	
Output capacitance	Coss		60				
Reverse transfer capacitance	Crss		25				
Gate resistance	Rg	Vgs=0V, Vds=0V, f=1MHz	1.30	1.65	2.00	Ω	
SWITCHING PARAMETERS							
Total gate charge (10V)	Qg	Vgs=10V, Vds=30V Id=4.5A		8.5	10.5	nC	
Total gate charge (4.5V)	Qg		4.3	5.5			
Gate-source charge	Qgs		1.6				
Gate-drain charge	Qgd		2.2				
Turn-on delay time	td(on)		4.7				
Turn-on rise time	tr		2.3				
Turn-off delay time	td(off)	15.7					
Turn-off fall time	tf	1.9					
Body diode reverse recovery time	trr	If=4.5A, dl/dt=100A/μs		27.5	35.0	ns	
Body diode reverse recovery charge	Qrr	If=4.5A, dl/dt=100A/μs		32.0		nC	

NOTE :

1. The value of Rθja is measured with the device mounted on 1in² FR-4 board of 2oz. Copper, in still air environment with Ta=25°C. The value in any given applications depends on the user's specific board design, The current rating is based on the t ≤ 10s thermal resistance rating.
2. Repetitive rating, pulse width limited by junction temperature.
3. The Rθja is the sum of the thermal impedance from junction to lead Rθjl and lead to ambient.
4. The static characteristics in Figures 1 to 6 are obtained using 80μs pulses, duty cycle 0.5%max.
5. These tests are performed with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with Ta=25°C. The SOA curve provides a single pulse rating.

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Typical electrical and thermal characteristics

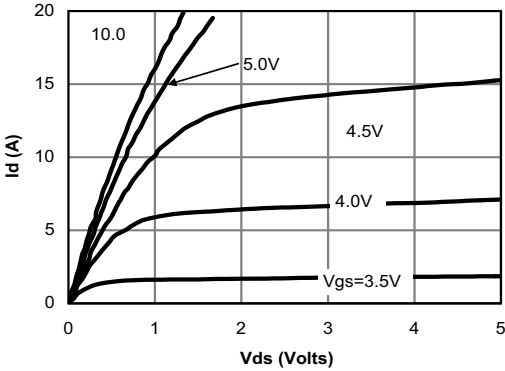


Fig 1: On-Region Characteristics

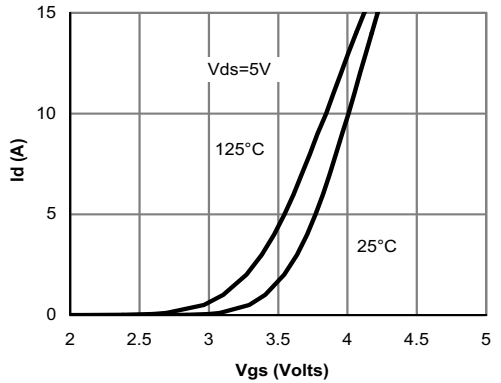


Figure 2: Transfer Characteristics

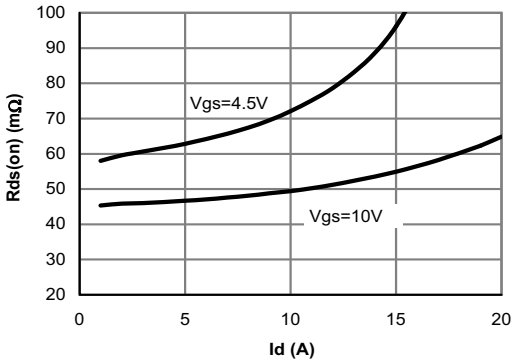


Figure 3: On-Resistance vs. Drain Current and Gate Voltage

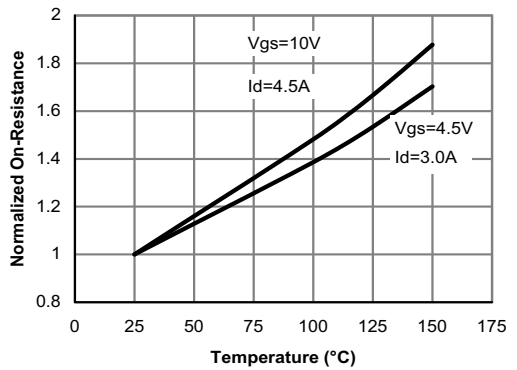


Figure 4: On-Resistance vs. Junction Temperature

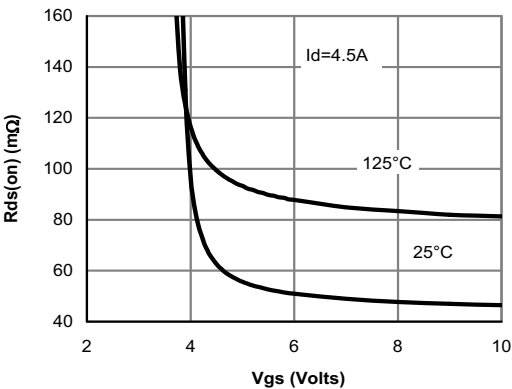


Figure 5: On-Resistance vs. Gate-Source Voltage

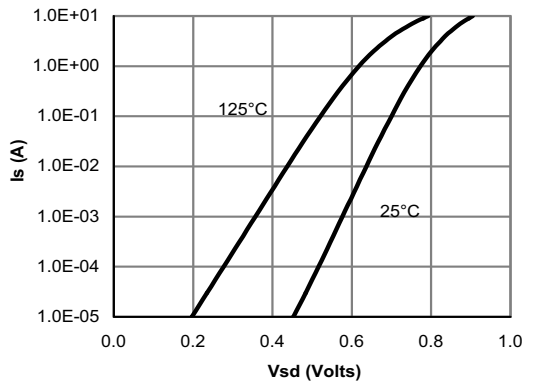


Figure 6: Body-Diode Characteristics

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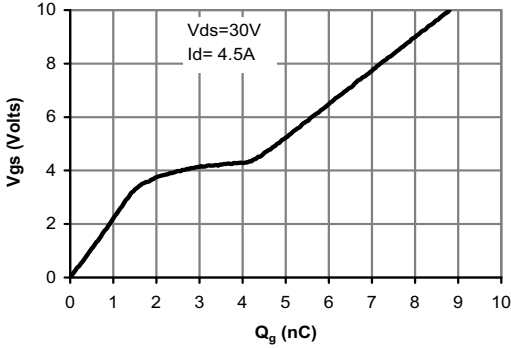


Figure 7: Gate-Charge Characteristics

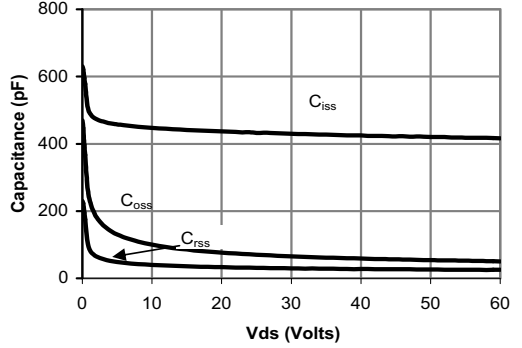


Figure 8: Capacitance Characteristics

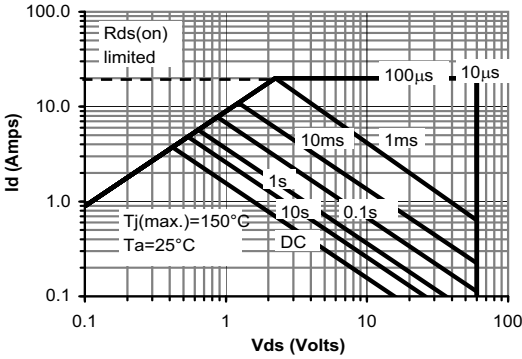


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

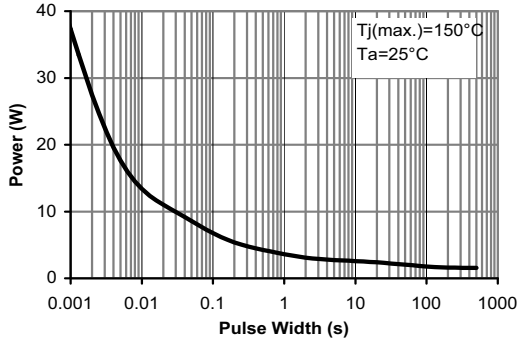


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

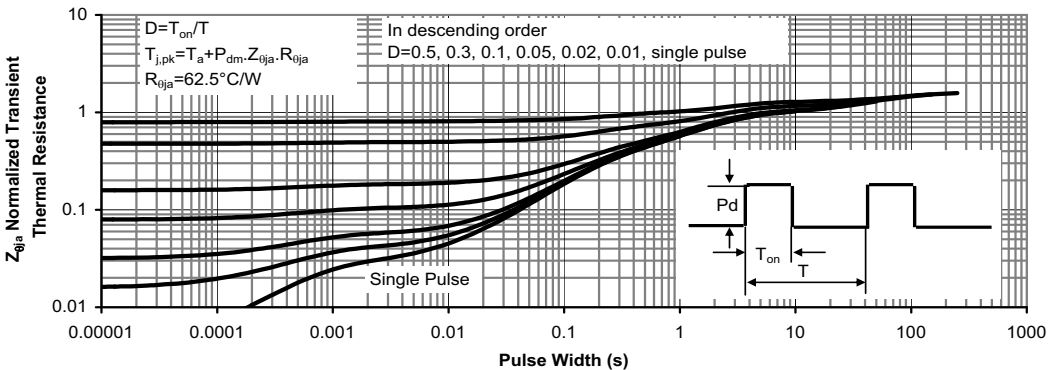


Figure 11: Normalized Maximum Transient Thermal Impedance